#### TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE

# 2SK1310A

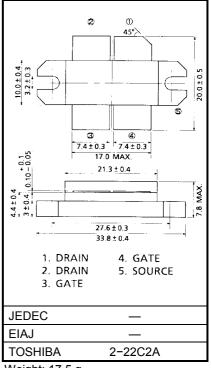
#### RF POWER MOS FET for VHF TV BROADCAST TRANSMITTER

Push-Pull Structure Package

### MAXIMUM RATINGS (Tc = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V <sub>DSS</sub>	100	V
Gate-Source Voltage	V <sub>GSS</sub>	±20	V
Drain Current	I <sub>D</sub>	12	Α
Reverse Drain Current	I <sub>DR</sub>	12	Α
Drain Power Dissipation	PD	250	W
Channel Temperature	T <sub>ch</sub>	150	°C
Storage Temperature Range	T <sub>stg</sub>	-55~150	°C

Unit in mm



Weight: 17.5 g

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damage to property.

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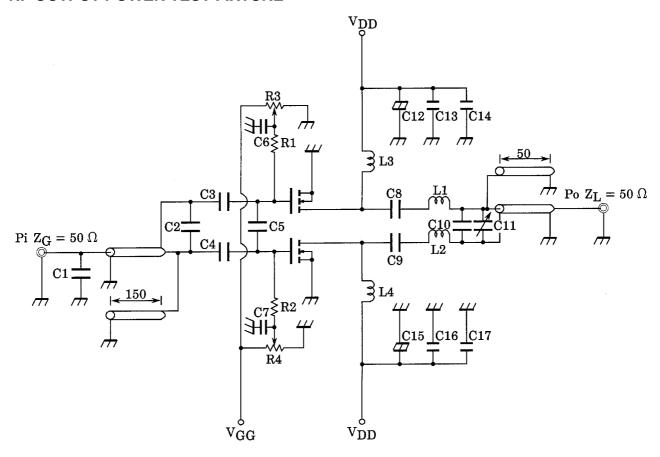
# ELECTRICAL CHARACTERISTICS (Tc = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Output Power	Ро	V <sub>DD</sub> = 50 V, I <sub>idle</sub> = 0.2 A × 2	190	220	_	W
Drain Efficiency	ηD	Pi = 10 W, f = 230 MHz *	_	65	_	%
Drain-Source Breakdown Voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0	100	_	_	V
Drain Cut-off Current	I <sub>DSS</sub>	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0	_	_	1.0	mA
Gate Threshold Voltage	V <sub>th</sub>	I <sub>D</sub> = 1 mA, V <sub>DS</sub> = 10 V	0.5	_	3.0	V
Drain-Source ON Resistance	R <sub>DS (on)</sub>	I <sub>D</sub> = 4 A, V <sub>GS</sub> = 10 V **	_	0.9	1.5	Ω
Drain-Source ON Voltage	V <sub>DS (on)</sub>	I <sub>D</sub> = 4 A, V <sub>GS</sub> = 10 V **	_	3.6	6.0	V
Forward Transfer Admittance	Y <sub>fs</sub>	I <sub>D</sub> = 3 A, V <sub>DS</sub> = 20 V **	0.9	1.3	_	S
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0, f = 1 MHz	_	100	_	pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0, f = 1 MHz	_	40	_	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0, f = 1 MHz	_	1	_	pF

<sup>\*:</sup> Push-Pull Operation \*\*: Pulse Test

This transistor is the electrostatic sensitive device. Please handle with caution.

#### RF OUTPUT POWER TEST FIXTURE



C1: MICA CAPACITOR 1pF C2: 33 pF  $\times$  3 (PARALLEL) MICA CAPACITOR

C3, C4, C8, C9, C13, C16: MICA CAPACITOR 1000 pF

MICA CAPACITOR C5: 33 pF  $0.01\,\mu\text{F} \times 2\,(\text{PARALLEL})$  CERAMIC CAPACITOR C6, C7:

C10: 14 pF MICA CAPACITOR AIR TRIMMER CAPACITOR C11: ~20 pF ELECTROLYTIC CAPACITOR

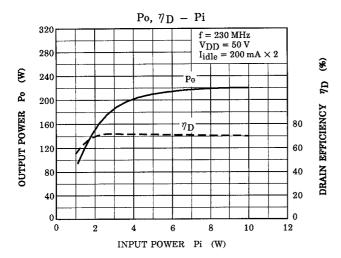
C12, C15 :  $100 \mu$ F, 100 VCERAMIC CAPACITOR C14, C17: 4700 pF

L1, L2: 0.5T, 5ID ø1.0 SILVER PLATED COPPER WIRE

L3, L4 : 3.0T, 5ID ø1.0 SILVER PLATED COPPER WIRE

220  $\Omega \times 2$  (PARALLEL) R1, R2:

R3, R4: VARIABLE RESISTOR  $1\,\mathrm{k}\Omega$ 



## **CAUTION**

These are only typical curves and devices are not necessarily guaranteed at these curves.